



EEC-41
AC/DC/IR/GB TESTER
User Manual

E1.00

WARRANTY

EEC certifies that the instrument listed in this manual meets or exceeds published manufacturing specifications. This instrument was calibrated using standards that are traceable to Chinese National Laboratory Accreditation (CNLA).

Your new instrument is warranted to be free from defects in workmanship and material for a period of (1) year from date of shipment. During the warranty period, you must return the instrument to EEC or its branches or its authorized distributor for repair. EEC reserves the right to use its discretion on replacing the faulty parts or replacing the assembly or the whole unit.

Any non-authorized modifications, tampering or physical damage will void your warranty. Elimination of any connections in the earth grounding system or bypassing any safety systems will void this warranty. This warranty does not cover batteries or accessories not of EEC manufacture. Parts used must be parts that are recommended by EEC as an acceptable specified part. Use of non-authorized parts in the repair of this instrument will void the warranty.

This warranty does not cover accessories not of EEC manufacture.

Except as provided herein, EEC makes no warranties to the purchaser of this instrument and all other warranties, express or implied (including, without limitation, merchantability or fitness for a particular purpose) are hereby excluded, disclaimed and waived.

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Safety Precautions

GENERAL

This product and its related documentation must be reviewed for familiarization with safety markings and instructions before operation. This product is a Safety Class I tester (provided with a protective earth terminal).

Before applying power, verify installed fuse and input voltage supplied to tester are within specifications.



INSTRUCTION MANUAL SYMBOL. PLEASE REFER TO THE INSTRUCTION MANUAL FOR SPECIFIC WARNING OR CAUTION INFORMATION TO AVOID PERSONAL INJURY OR DAMAGE TO THE PRODUCT



INDICATES HAZARDOUS VOLTAGES MAY BE PRESENT.



CHASSIS GROUND SYMBOL.

WARNING

CALLS ATTENTION TO A PROCEDURE, PRACTICE, OR CONDITION, THAT COULD POSSIBLY CAUSE BODILY INJURY OR DEATH.

CAUTION

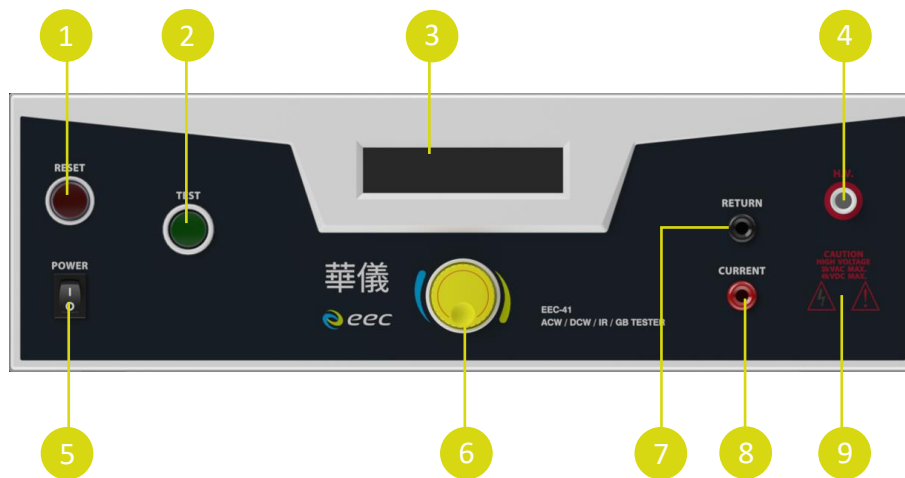
Calls attention to a procedure, practice, or condition that could cause damage to equipment or permanent loss of data.

WARNING

A HIPOT PRODUCES VOLTAGES AND CURRENTS WHICH CAN CAUSE HARMFUL OR FATAL ELECTRIC SHOCK. TO PREVENT ACCIDENTAL INJURY OR DEATH, THESE SAFETY PROCEDURES MUST BE STRICTLY OBSERVED

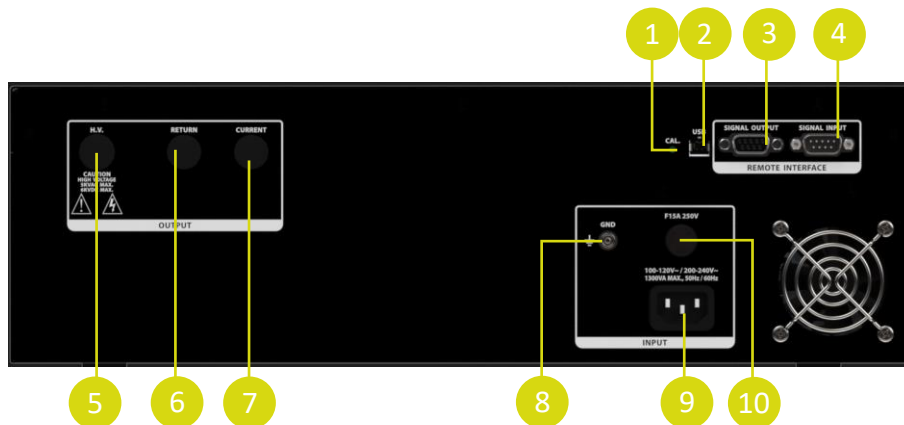
WHEN HANDLING AND USING HTE TESTER.

Front Panel Controls



- 1 RESET BUTTON** - This is a momentary contact switch used to reset the tester. If an out-of-range reading is detected during a test, the red failure lamp within the button will light. To reset the system for the next test, press and release this button. This button may also be used to abort a test in progress.
- 2 TEST BUTTON** - This is a momentary contact switch used to start a test. Press the green button to turn on the high voltage output when in test mode. The indicator lamp within the button will light when there is continuity between Cont. Check and Return ports.
- 3 LCD DISPLAY** - The Liquid Crystal Display is the main display for the operator and programmer of the test settings and test results.
- 4 HIGH VOLTAGE OUTPUT JACK** - Use this jack for the connection of the detachable high voltage test lead or the adapter box high voltage connector.
- 5 POWER SWITCH** - Rocker-style switch with international ON (|) and OFF (0) markings.
- 6 ROTARY KNOB** - Use this knob to advance forward/backward through the setup menus and to setup system and test parameters.
- 7 RETURN TERMINAL** - Connector used to attach the return test lead, adapter box return lead or test fixture return lead to the instrument. This connection provides the return current path.
- 8 CURRENT OUTPUT TERMINAL** - Connector used to attach the high current output lead, adapter box high current lead or test fixture high current lead to the instrument. This connection provides the output current for the ground bond.
- 9 HIGH VOLTAGE LED INDICATOR** - This indicator flashes to warn the operator that high voltage is present at the high voltage output terminal.

Rear Panel Controls

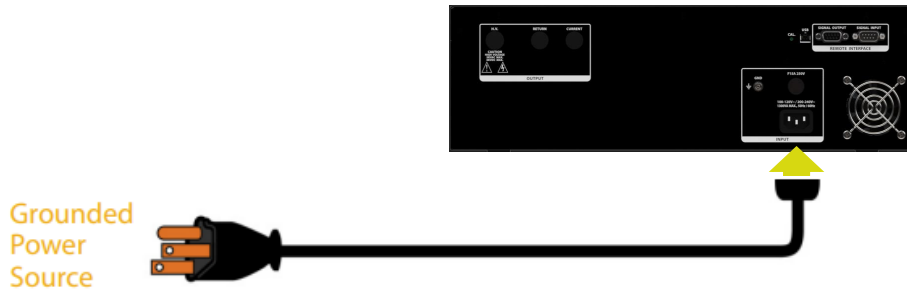


- 1 **CALIBRATION ENABLE KEY** - To enter the calibration mode press this key while the tester is being powered ON.
- 2 **USB CONNECTOR** - Optional USB port for serial communication. Refer to Option 02 in the Options section.
- 3 **SIGNAL OUTPUT** - 9 pin D subminiature female connector for monitoring PASS, FAIL, and PROCESSING output relay signals.
- 4 **SIGNAL INPUT** - 9 pin D subminiature male connector for remote control of test, reset, and interlock functions as well as remote memory tests selection.
- 5 **OPTIONAL HIGH VOLTAGE OUTPUT PORT** - Use this jack for the connection of the detachable high voltage test lead or the high voltage adapter box.
- 6 **OPTIONAL RETURN PORT** - This connection provides the return current path.
- 7 **OPTIONAL CURRENT OUTPUT PORT** - This connection provides the output current for the ground bond
- 8 **CHASSIS GROUND EARTH TERMINAL** - This safety ground terminal should be connected to a good earth ground before operation.
- 9 **INPUT POWER RECEPTACLE** - Standard IEC 320 connector for connection to a standard NEMA style line power (mains) cord.
- 10 **FUSE RECEPTACLE** - To change the fuse, unplug the power (mains) cord, push and turn the fuse receptacle counter-clockwise. Please replace the fuse with one of the proper rating.

Setup Instructions

Power-Up Sequence:

1. Check to be sure the correct input line cord is used.
2. Connect the power input plug into its socket on the rear panel of the tester. The tester has an automatic input voltage range selection.
3. Connect the male end of the plug to the grounded AC outlet.



WARNING

PLEASE BE SURE THAT THE SAFETY GROUND ON THE POWER LINE CORD IS NOT DEFEATED AND THAT YOU ARE CONNECTING TO A GROUNDED POWER SOURCE. ALSO, CONNECT THE REAR PANEL CHASSIS GROUND FOR ADDITIONAL SAFETY.

4. Connect the Interlock Disable key to the Signal Input connector on the back panel of the tester. This is required in order to run a test.



5. Turn on the POWER switch located on the lower left hand side of the front panel. Upon powering the tester up, a POWER ON SELF TEST (POST) will automatically be performed. This test will check for the condition of the RAM chips, PCB's and other critical components. In addition the display will show the following message, with the actual model number and software version number.



6. The tester will recall the last memory program that was active and the display will show the parameters that were programmed into that memory. The tester is now ready for operation.

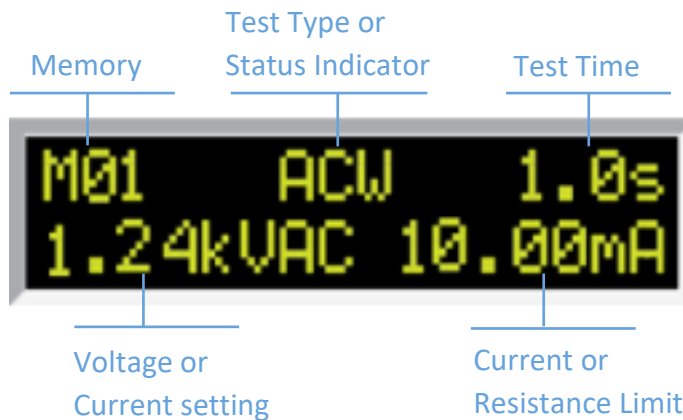
Getting to Know Your Tester

Working with Memories

The testers are equipped with 3 memory programs numbered 1 through 3. Each memory can be connected sequentially to the next consecutive memory. Only one test type can be selected for each memory location. However, all 3 memory locations can be programmed and the parameters will be saved in each memory. The tests loaded in each memory location can be executed one at a time or as a sequence.

Perform Test Screen

The Perform Test Screen displays the following parameters:



Follow the setup procedures to set the desired parameters. The display will show the either the Hipot test settings or the Insulation Resistance test settings

Display*	Description
	AC Hipot test display
	DC Hipot test display
	Insulation Resistance test display
	Ground Bond test display

Program a Memory

1. M01 DCW 1.0s
1.24kVAC 5mA



Home Screen

2. BACK <M01> M02
1.24kVAC 5mA



Turn the yellow rotary knob to scroll to M01 to edit Memory 1. (M02=Memory 2, etc.)

3. M01 DCW 1.0s
1.24kVAC 5mA



When M01 is selected, press the yellow knob to recall Memory 1.

4. BACK <TYPE> VOLT
1.24kVAC 5mA



Press the knob again to edit Memory 1. The first parameter that will be selected is TYPE.

Continue to edit each parameter as needed for Memory 1.

GO BACK TO THE MAIN MENU

1. SCTY <PLC> BACK
OFF



Turn the yellow knob to scroll to BACK in order to return to the Main Menu.

2. PLC <BACK> M1
EXIT TO MAIN



When BACK is selected, press the knob. You will be returned to the Main Menu

3. M01 ACW 0.0s
0.00kVAC 100mΩ




Main Menu.

TYPE AC

1. 




Turn the yellow rotary knob to scroll to desired parameter to edit TYPE.

2. 

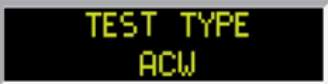


When TYPE is selected, press the rotary knob to edit the Test Type. The options will blink.

3. 




Turn the rotary knob to change the Test Type: ACW, DCW, IR or GB.

4. 




Press the rotary knob to select the Test Type.

5. 



You will be returned to the previous menu.

Change Voltage (AC)

1. 



Turn the yellow rotary knob to scroll to desired parameter to edit VOLT.

2. 

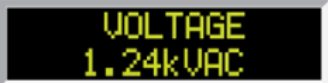


When VOLT is selected, press the rotary knob to edit the Voltage. The first digit of Voltage will blink.

3. 




Turn the rotary knob to change the Voltage setting for each digit.

4. 



Press the rotary knob to select the setting and move to the next digit.

5. 



When done, you will be returned to the previous menu.

Change HI-Limit(AC)

1. VOLT <HI-L> LO-L
0.10mA



Turn the yellow rotary knob to scroll to desired parameter to edit HI-L.

2. HI-LIMIT
0.10mA



When HI-L is selected, press the rotary knob to edit the HI-Limit. The first digit of HI-Limit will blink.

3. HI-LIMIT
5mA



Turn the rotary knob to change the HI-Limit setting for each digit.

4. HI-LIMIT
5mA



Press the rotary knob to select the setting and move to the next digit.

5. VOLT <HI-L> LO-L
5mA



When done, you will be returned to the previous menu.

Change LO-Limit (AC)

1. HI-L <LO-L> RAMP
0mA



Turn the yellow rotary knob to scroll to desired parameter to edit LO-L.

2. LO-LIMIT
0mA



When LO-L is selected, press the rotary knob to edit the LO-Limit. The first digit of LO-Limit will blink.

3. LO-LIMIT
1mA



Turn the rotary knob to change the LO-Limit setting for each digit.

4. LO-LIMIT
1mA



Press the rotary knob to select the setting and move to the next digit.

5. HI-L <LO-L> RAMP
1mA




When done, you will be returned to the previous menu.

Change Ramp (AC)

1. 



Turn the yellow rotary knob to scroll to desired parameter to edit RAMP.

2. 




When RAMP is selected, press the rotary knob to edit the Ramp Time. The first digit of Ramp Time will blink.

3. 



Turn the rotary knob to change the Ramp Time for each digit.

4. 




Press the rotary knob to select the setting and move to the next digit.

5. 



When done, you will be returned to the previous menu.

Change Dwell (AC)

1. 



Turn the yellow rotary knob to scroll to desired parameter to edit DWLL.

2. 




When DWLL is selected, press the rotary knob to edit the Dwell Time. The first digit of Dwell Time will blink.

3. 



Turn the rotary knob to change the Ramp Time for each digit.

4. 



Press the rotary knob to select the setting and move to the next digit.

5. 



When done, you will be returned to the previous menu.

Change Frequency (AC)

1. CONT <FREQ> CONN
60Hz



Turn the yellow rotary knob to scroll to desired parameter to edit FREQ.

2. FREQUENCY
60Hz



When FREQ is selected, press the rotary knob to edit the Frequency. The options will blink.

3. FREQUENCY
50Hz



Turn the rotary knob to change the Frequency setting: 50Hz or 60Hz.

4. FREQUENCY
50Hz



Press the rotary knob to select the setting.

5. CONT <FREQ> CONN
50Hz



You will be returned to the previous menu.

Change Connect (AC)

1. FREQ <CONN> BACK
OFF



Turn the yellow rotary knob to scroll to desired parameter to edit CONN.

2. CONNECT
OFF



When CONN is selected, press the rotary knob to edit the Connect Setting. The options will blink.

3. CONNECT
ON



Turn the rotary knob to change the Connect setting: ON or OFF.

4. CONNECT
ON



Press the rotary knob to select the setting and move to the next digit.

5. FREQ <CONN> BACK
ON



When done, you will be returned to the previous menu.

TYPE DC

1. BACK <TYPE> VOLT
0.00kVAC 5.00mA



Turn the yellow rotary knob to scroll to desired parameter to edit TYPE.

2. TEST TYPE
ACW



When TYPE is selected, press the rotary knob to edit the frequency. The options will blink.

3. TEST TYPE
DCW



Turn the rotary knob to change the Test Type: ACW, DCW or IR.

4. TEST TYPE
DCW



Press the rotary knob to select the setting.

5. BACK <TYPE> VOLT
DCW



You will be returned to the previous menu.

Change Voltage (DC)

1. TYPE <VOLT> HI-L
1.24kVDC



Turn the yellow rotary knob to scroll to desired parameter to edit VOLT.

2. VOLTAGE
1.24kVDC



When VOLT is selected, press the rotary knob to edit the Voltage. The first digit of Voltage will blink.

3. TYPE <VOLT> HI-L
1.50kVDC



Turn the rotary knob to change the Voltage setting for each digit.

4. TYPE <VOLT> HI-L
1.50kVDC



Press the rotary knob to select the setting and move to the next digit.

5. TYPE <VOLT> HI-L
1.50kVDC



When done, you will be returned to the previous menu.

Change HI-Limit (DC)

1. 

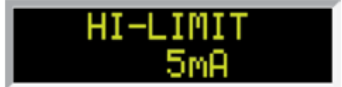


Turn the yellow rotary knob to scroll to desired parameter to edit HI-L.

2. 

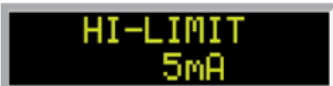


When HI-L is selected, press the rotary knob to edit the HI-Limit. The first digit of HI-Limit will blink.

3. 



Turn the rotary knob to change the HI-Limit setting for each digit.

4. 



Press the rotary knob to select the setting and move to the next digit.

5. 



When done, you will be returned to the previous menu.

Change LO-Limit (DC)

1. 



Turn the yellow rotary knob to scroll to desired parameter to edit LO-L.

2. 




When LO-L is selected, press the rotary knob to edit the LO-Limit. The first digit of LO-Limit will blink.

3. 




Turn the rotary knob to change the LO-Limit setting for each digit.

4. 



Press the rotary knob to select the setting and move to the next digit.

5. 



When done, you will be returned to the previous menu.

Change Ramp (DC)

1. LO-L <RAMP> DWLL
0.2s



Turn the yellow rotary knob to scroll to desired parameter to edit RAMP.

2. RAMP
000.2s



When RAMP is selected, press the rotary knob to edit the Ramp Time. The first digit of Ramp Time will blink.

3. RAMP
001.0s



Turn the rotary knob to change the Ramp Time for each digit.

4. RAMP
001.0s



Press the rotary knob to select the setting and move to the next digit.

5. LO-L <RAMP> DWLL
1.0s



When done, you will be returned to the previous menu.

Change Dwell (DC)

1. RAMP <DWLL> CONN
0.2s



Turn the yellow rotary knob to scroll to desired parameter to edit DWLL.

2. DWELL
01.0s



When DWLL is selected, press the rotary knob to edit the Dwell Time. The first digit of Dwell Time will blink.

3. DWELL
01.5s



Turn the rotary knob to change the Ramp Time for each digit.

4. DWELL
01.5s



Press the rotary knob to select the setting and move to the next digit.

5. RAMP <DWLL> CONN
1.5s



When done, you will be returned to the previous menu.

Change Connect (DC)

1. DWLL <CONN> BACK
OFF



Turn the yellow rotary knob to scroll to desired parameter to edit CONN.

2. CONNECT
OFF



When CONN is selected, press the rotary knob to edit the Connect Setting. The options will blink.

3. CONNECT
ON



Turn the rotary knob to change the Connect setting: ON or OFF.

4. CONNECT
ON



Press the rotary knob to select the setting and move to the next digit.

5. DWLL <CONN> BACK
OFF



When done, you will be returned to the previous menu.

TYPE IR

1. BACK <TYPE> VOLT
0.00kVAC 5.00mA



Turn the yellow rotary knob to scroll to desired parameter to edit TYPE.

2. TEST TYPE
ACW



When TYPE is selected, press the rotary knob to edit the Dwell Time. The first digit of Dwell Time will blink.

3. TEST TYPE
IR



Turn the rotary knob to change the Test Type: ACW, DCW or IR.

4. TEST TYPE
IR



Press the rotary knob to select the setting and move to the next digit.

5. BACK <TYPE> VOLT
IR



When done, you will be returned to the previous menu.

Change Voltage (IR)

1. TYPE <VOLT> HI-L
500VDC



Turn the yellow rotary knob to scroll to desired parameter to edit VOLT.

2. VOLTAGE
500VDC



When VOLT is selected, press the rotary knob to edit the Connect Setting. The options will blink.

3. VOLTAGE
1000VDC



Turn the rotary knob to change the Voltage setting for each digit.

4. VOLTAGE
1000VDC



Press the rotary knob to select the setting and move to the next digit.

5. TYPE <VOLT> HI-L
1000VDC



When done, you will be returned to the previous menu.

Change HI-Limit (IR)

1. VOLT <HI-L> LO-L
0M Ω



Turn the yellow rotary knob to scroll to desired parameter to edit HI-L.

2. HI-LIMIT
0M Ω



When HI-L is selected, press the rotary knob to edit the HI-Limit. The first digit of HI-Limit will blink.

3. HI-LIMIT
1M Ω



Turn the rotary knob to change the HI-Limit for each digit.

4. HI-LIMIT
1M Ω



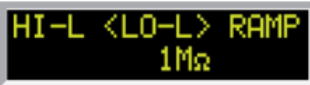
Press the rotary knob to select the setting and move to the next digit.

5. VOLT <HI-L> LO-L
1M Ω



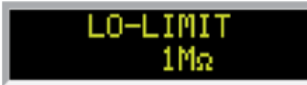
When done, you will be returned to the previous menu.

Change LO-Limit (IR)

1. 

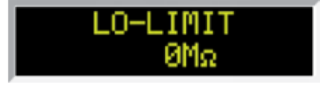


Turn the yellow rotary knob to scroll to desired parameter to edit LO-L.

2. 




When LO-L is selected. Press the rotary knob to edit the LO-Limit. The first digit of LO-Limit will blink.

3. 



Turn the rotary knob to change the LO-Limit setting for each digit.

4. 



Press the rotary knob to select the setting and move to the next digit.

5. 




When done, you will be returned to the previous menu.

Change Ramp (IR)

1. 




Turn the yellow rotary knob to scroll to desired parameter to edit RAMP.

2. 




When RAMP is selected. Press the rotary knob to edit the Ramp Time. The first digit of Ramp Time will blink.

3. 




Turn the rotary knob to change the Ramp Time for each digit.

4. 



Press the rotary knob to select the setting and move to the next digit.

5. 



When done, you will be returned to the previous menu.

Change Delay (IR)

1. RAMP <DLAY> CØNN
1.0s



Turn the yellow rotary knob to scroll to desired parameter to edit DLAY.

2. DELAY
001.0s



When DLAY is selected. Press the rotary knob to edit the Delay Time. The first digit of Delay Time will blink.

3. DELAY
002.0s



Turn the rotary knob to change the Delay Time for each digit.

4. DELAY
002.0s



Press the rotary knob to select the setting and move to the next digit.

5. RAMP <DLAY> CØNN
2.0s



When done, you will be returned to the previous menu.

Change Connect (IR)

1. DLAY <CONN> BACK
OFF



Turn the yellow rotary knob to scroll to desired parameter to edit CONN.

2. CONNECT
OFF



When CONN is selected. Press the rotary knob to edit the Connect Setting. The options will blink.

3. CONNECT
ON



Turn the rotary knob to change the Connect setting: ON or OFF.

4. CONNECT
ON



Press the rotary knob to select the setting.

5. DLAY <CONN> BACK
ON




When done, you will be returned to the previous menu.

TYPE GND

1. 



Turn the yellow rotary knob to scroll to desired parameter to edit, **TYPE**.

2. 



When **TYPE** is selected. Press the rotary knob to edit the Test Type. The options will blink.

3. 



Turn the rotary knob to change the Test Type: **ACW, DCW, IR or GND**.

4. 



Press the rotary knob to select the Test Type.

5. 



When done, you will be returned to the previous menu.

Change Current (GND)

1. 



Turn the yellow rotary knob to scroll to desired parameter to edit **CURR**.

2. 



When **CURR** is selected. Press the rotary knob to edit the Current. The first digit of Current will blink.

3. 



Turn the rotary knob to change the Current for each digit.

4. 



Press the rotary knob to select the setting and move to the next digit.

5. 



When done, you will be returned to the previous menu.

Change HI-Limit (GND)

1. CURR <HI-L> LO-L
100mΩ



Turn the yellow rotary knob to scroll to desired parameter to edit HI-L.

2. HI-LIMIT
100mΩ



When HI-L is selected. Press the rotary knob to edit the HI-Limit. The first digit of HI-Limit will blink.

3. HI-LIMIT
200mΩ



Turn the rotary knob to change the HI-Limit setting for each digit.

4. HI-LIMIT
200mΩ



Press the rotary knob to select the setting and move to the next digit.

5. CURR <HI-L> LO-L
200mΩ



When done, you will be returned to the previous menu.

LO-Limit (GND)

1. HI-L <LO-L> RAMP
0mΩ



Turn the yellow rotary knob to scroll to desired parameter to edit LO-L.

2. LO-LIMIT
0mΩ



When LO-L is selected. Press the rotary knob to edit the LO-Limit. The first digit of LO-Limit will blink.

3. LO-LIMIT
10mΩ



Turn the rotary knob to change the LO-Limit setting for each digit.

4. LO-LIMIT
10mΩ



Press the knob to select the setting and move to the next digit.

5. HI-L <LO-L> RAMP
10mΩ



When done, you will be returned to the previous menu.

Change Dwell (GND)

1. L0-L <DWLL> FREQ
1.0s



Turn the yellow rotary knob to scroll to desired parameter to edit DWLL.

2. DWELL
01.0s



When DWLL is selected. Press the rotary knob to edit the Dwell Time. The first digit of Dwell Time will blink.

3. DWELL
01.5s



Turn the rotary knob to change the Ramp Time for each digit.

4. DWELL
01.5s



Press the rotary knob to select the setting and move to the next digit.

5. L0-L <DWLL> FREQ
1.5s



When done, you will be returned to the previous menu.

Change Frequency (GND)

1. DWLL <FREQ> OFFS
60Hz



Turn the yellow rotary knob to scroll to desired parameter to edit FREQ.

2. FREQUENCY
60Hz



When FREQ is selected. Press the rotary knob to edit the Frequency. The options will blink.

3. FREQUENCY
50Hz



Turn the rotary knob to change the Frequency setting: 50Hz or 60Hz.

4. FREQUENCY
50Hz



Press the rotary knob to select the setting.

5. DWLL <FREQ> OFFS
50Hz



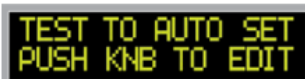
You will be returned to the previous menu.

Change Offset (Manual)

1. 




Turn the yellow rotary knob to scroll to desired parameter to edit OFFS.

2. 



When OFFS is selected. Press the rotary knob to edit the Offset.

3. 




Turn the rotary knob to change the Offset setting.

4. 



Press the rotary knob to select the setting.

5. 



You will be returned to the previous menu.

Change Offset (Auto)

1. 



When OFFS is selected. Push the rotary knob to edit the Offset. The options will blink.

2. 

Short the Red High Current lead with the Black Return Lead as shown above.


3. 

Push the green TEST button to start reading the offset value. CAUTION: The tester will start outputting once the TEST button is pressed.

4. 



Tester performing Auto Offset.

5. 



Push the knob to select the setting.

Change Connect

1. OFFS <CONN> BACK
OFF



Turn the yellow rotary knob to scroll to desired parameter to edit CONN.

2. CONNECT
OFF



When CONN is selected. Press the rotary knob to edit the Connect Setting. The options will blink.

3. CONNECT
ON



Turn the rotary knob to change the Connect setting: ON or OFF.

4. CONNECT
ON



Press the rotary knob to select the setting.

5. OFFS <CONN> BACK
ON



You will be returned to the previous menu.

Go Back to the Home Screen

1. OFFS <CONN> BACK
OFF



Turn the yellow rotary knob to scroll to BACK in order to scroll to the home screen.

2. CONN <BACK> M1
EXIT TO MAIN



When BACK is selected, press the rotary knob. You will be returned to the home screen.

3. M1 GND 1.0s
25.0A 100mΩ



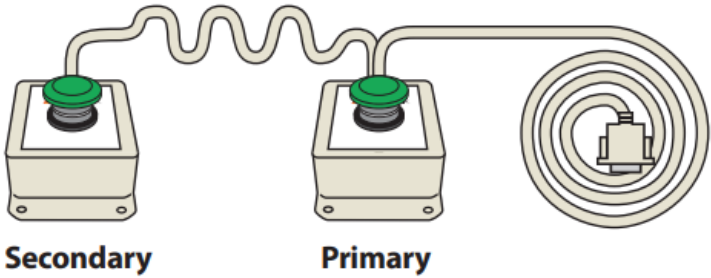
Home Screen

System Parameter Descriptions

System Parameter	Setting	Description
SCTY (security) *2	OFF	With SCTY set to OFF, all test and system parameters can be edited.
	RUN	With SCTY set to RUN, the user will not be able to recall any of the memory locations or edit any of the test and system parameters. With this setting if the user attempts to edit any test or system parameter the following message will be displayed, "Security is RUN, can't be edited."
	MEM	With SCTY set to MEM, the user will be able to recall any of the 5 available memory locations. The user will not be able to edit any test or system parameters.
PLC Remote	ON/OFF	Allows the user to initiate a test through the REMOTE INPUT on the rear panel of the tester. If PLC Remote = ON the front panel TEST button is disabled and a test may only be started through the rear panel I/O. If PLC Remote = OFF, the test must be initiated via the front panel TEST button.
DUAL TEST	ON/OFF	Allows the user to initiate a test through use of Dual Test Switch connected to the Signal Input port of the tester. This functionality requires PLC Remote parameter to be set to ON. If DUAL Test = ON, the front panel TEST button is disabled and a test may only be started by pressing dual test switches within 0.5 seconds of one another. If DUAL Test = OFF, the regular PLC remote operation applies*1.
SINGLE STEP (SS)	ON/OFF	If Single Step = ON, the instrument will pause after each step is completed, even if Step Connect function is set to ON. To continue the test sequence, press the TEST button to execute the next connected step. Each time the TEST button is pressed the next connected step will execute. If you press the RESET button before completing all connected steps, it will return the instrument to the original starting step. If a step fails and you wish to continue to the next step, do not press the RESET button but press the TEST button.
FAIL STOP (FS)	ON/OFF	If Fail Stop = ON, a sequence of tests will stop if a failure occurs. If Fail Stop = OFF, the sequence of tests will continue to the end of the sequence regardless of whether or not a failure has occurred. If a failure has occurred, the red RESET button will light and alarm will sound indicating failure during the sequence. Pressing the RESET button will silence the alarm and reset the instrument.
GFI	ON/OFF	Since the leakage current measuring circuit of the instrument monitors only current that flows through the return lead, the possibility exists for current to flow directly from the high voltage output to earth ground without being measured. The GFI (Ground Fault Interrupt) circuit monitors the current between the high voltage output and earth ground. Therefore, if you touch the high voltage lead and earth

		ground, the instrument will detect this hazardous condition and shut off immediately
--	--	--

*1 If running a sequence of connected tests and all tests pass, the Dual Remote Palm switches will send a RESET signal to the tester at the end of the sequence. If a test in the sequence fails, the Dual Palm Remote switches will not send a RESET signal to the tester. In this case a reset can be performed by either using the front panel RESET button or by pressing the primary switch of the Dual Palm Remote switches. The primary switch of the Dual Remote Palm switches is directly connected to the Signal Input of the tester. If no RESET signal is received by the tester, the next press of the Dual Palm Remote switch would advance and run the next step in the memory



Dual Palm Remote Switches (Sold Separately)

*2 Anytime the Security setting is changed the user will be asked to enter a PIN number. This PIN will be required again if the Security parameter needs to be set to a different setting. Refer to the Edit Security flow chart for instructions on setting the pin.

Setting System Parameters

Edit Security Settings

1. 



Default screen.

2. 



Turn the yellow rotary knob to scroll to **SCTY** to edit Security settings.

3. 



When **SCTY** is selected. Press the rotary knob to enter the Security settings. The options will blink.

4. 



Turn rotary knob to change the Security settings: **OFF**, **RUN** or **MEM**.

5. 




Press the rotary knob to select the Security setting option.

6. 



Enter a PIN number for the Security setting. Turn rotary knob to enter the PIN.

7. 



Press the rotary knob to save the PIN. This PIN will be required when the Security setting is edited.

8. 



You will be returned to the previous menu.

Edit PLC Remote Settings

1. 



Home screen.

2. 



Turn the yellow rotary knob to scroll to **PLC** to edit the PLC settings.

3. 

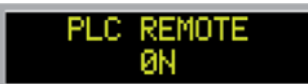


When **PLC** is selected. Press the rotary knob to enter the PLC settings. The options will blink.

4. 




Turn rotary knob to change the PLC settings: **ON** or **OFF**.

5. 



Press the rotary knob to select the PLC setting.

6. 



You will be returned to the previous menu.

Edit Dual Settings

1. 



Turn the yellow rotary knob to scroll to desired parameter to edit **DUAL**.

2. 



When **DUAL** is selected. Press the rotary knob to edit the Connect Setting. The options will blink.

3. 



Turn the rotary knob to change the Dual setting: **ON** or **OFF**.

4. 




Press the rotary knob to select the setting.

5. 



You will be returned to the previous menu.

Edit Single Step Settings

1. 



Turn the yellow rotary knob to scroll to desired parameter to edit **SINGLE STEP**.

2. 



When **SINGLE STEP** is selected, press the rotary knob to edit the Single Step Setting. The options will blink.

3. 



Turn the rotary knob to change the Single Step setting: **ON** or **OFF**.

4. 



Press the rotary knob to select the setting.

5. 




You will be returned to the previous menu.

Edit Fail Stop Settings

1. 

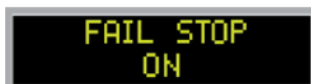


Turn the yellow rotary knob to scroll to desired parameter to edit **FAIL STOP**.

2. 

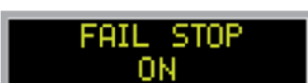


When **FAIL STOP** is selected, press the rotary knob to edit the Fail Stop Setting. The options will blink.

3. 



Turn the rotary knob to change the Fail Stop setting: **ON** or **OFF**.

4. 



Press the rotary knob to select the setting.

5. 



You will be returned to the previous menu.

Edit GFI Settings

1. FS <GFI> BACK
OFF



Turn the yellow rotary knob to scroll to desired parameter to edit GFI.

2. GFI
OFF



When GFI is selected, press the rotary knob to edit the GFI Setting. The options will blink.

3. GFI
ON



Turn the rotary knob to change the GFI setting: **ON** or **OFF**.

4. GFI
ON



Press the rotary knob to select the setting.



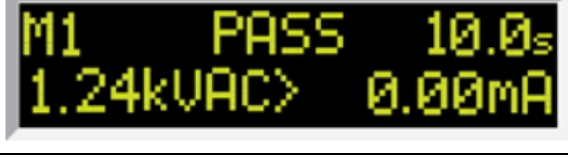


5. FS <GFI> BACK
ON



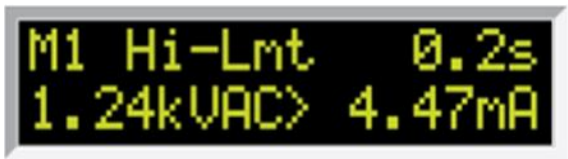


You will be returned to the previous menu.


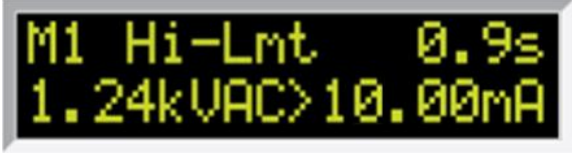


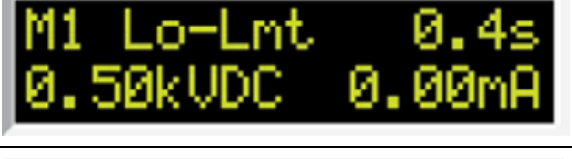
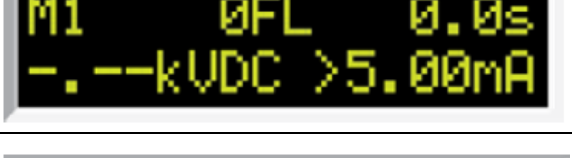



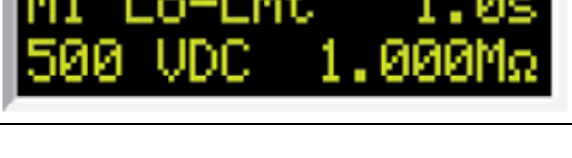
Using The Display


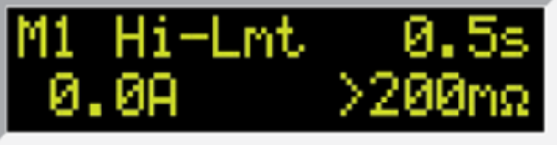
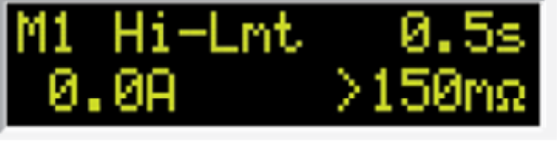


Test Mode Displays

Test Mode Display	Test Type	Description
	AC/DC Hipot & IR	Displayed when the test voltage is ramping up from 0.0 VAC/VDC to full test voltage.
	AC/DC Hipot & GND	Displayed when the test voltage has reached full potential. Dwell is the amount of time the potential is held at the set value.
	AC/DC Hipot, IR & GND	Displayed when a test sequence has passed. The green TEST button will illuminate and a short audible beep tone will be activated.
	AC/DC Hipot, IR & GND	Displayed if the operator elects to stop a test in process. This can be accomplished by pressing the RESET button during the test.
	IR	Displayed while the test is in process. If the insulation resistance value exceeds the set limits, the test will fail after the DELAY time has expired.

Failure Mode Displays

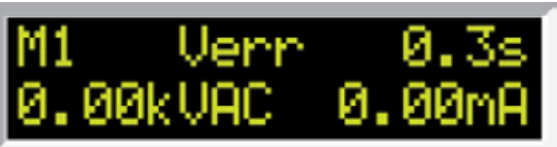
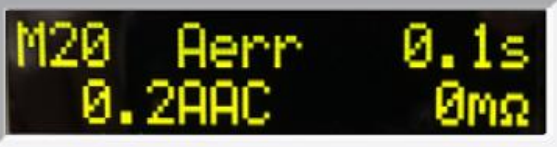
Test Mode Display*	Test Type	Description
	AC Hipot	Displayed if the leakage current exceeds the high limit setting, but does not exceed the metering range.
	AC Hipot	Displayed if the leakage current does not exceed the low limit setting.
	AC Hipot	Displayed if there is a short in the DUT during the first 300 mS of test.

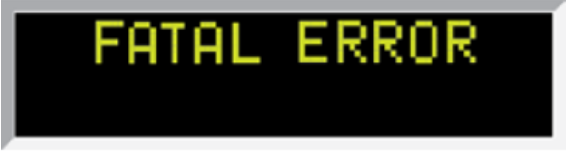
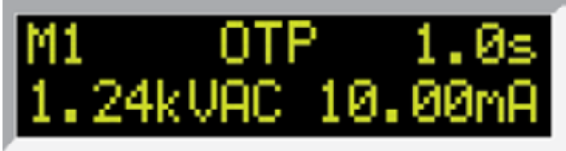
Test Mode Display*	Test Type	Description
	AC Hipot	Displayed if a flash over occurs in the DUT during the test, which results in an OFL condition due to the current exceeding the maximum metering range.
	AC Hipot	Displayed if the leakage current exceeds the metering range and neither a short circuit nor flash over occurred.
	DC Hipot	Displayed if the leakage current exceeds the high limit setting, but does not exceed the metering range.
	ACW DCW IR	This message appears on the display if the GFI threshold is exceeded during the test.
	DC Hipot	Displayed if the leakage current does not exceed the low limit setting.
	DC Hipot	Displayed if there is a short circuit in the DUT during the test.
	DC Hipot	Displayed if a flash over occurs in the DUT during the test, which results in an OFL condition due to the current exceeding the maximum metering range.
	IR	Displayed if the insulation resistance exceeds the high limit setting, but does not exceed the metering range.
	IR	Displayed if the insulation resistance exceeds the high limit setting, and exceeds the metering range.
	IR	Displayed if the leakage current does not exceed the low limit setting and is within the metering range.

Test Mode Display*	Test Type	Description
	GND	Displayed if the resistance exceeds the metering range. For current range 3.0 – 10.0A
	GND	Displayed if the resistance exceeds the metering range. For current range 10.1 – 30.0A
	GND	Displayed if the resistance exceeds the metering range. For current range 30.1 – 40.0A
	GND	Displayed if the resistance exceeds the high limit trip setting, but does not exceed the metering range.
	GND	Displayed if the resistance does not exceed the low limit setting.

*For all failures, the red RESET button will illuminate and an alarm will be activated. To stop the alarm, please press the RESET button once. The alarm will stop and the display will retain the failure information. The tester is now ready for the next test. If the RESET button is pressed again, the failure information will be cleared and the display will indicate the setting data of the executed test.

Error Messages

Test Mode Display	Description
	This message appears on the display, if the tester's output reading does not match the setting. When the tester has an output problem and the TEST button is pressed, the Output Error screen will appear. The failure light will illuminate and an alarm will be heard. Pressing the RESET key will allow you to return to the test mode. The failure light and alarm can be cleared by pressing the RESET button. If Output Error occurs please call the Customer Support Center at +60-3-78429168 for assistance.
	

	<p>All of the buttons and keys are not active in this situation. This type of failure permanently locks the tester in Fatal Error mode and then requires the tester to be serviced by an EEC authorized service center. Contact the Customer Support Center at +60-3-78429168 to receive further instruction.</p> <p>FATAL ERROR 9002 will appear on the display, if the tester's System data or the Model/Option data are corrupted and do not match the setting.</p> <p>FATAL ERROR 9003 will appear on the display, if the tester's Calibration data is corrupted.</p>
	<p>This message appears on the screen if the tester detects an over-temperature condition on the power amplifier. The fail light will illuminate and the alarm will be heard. The Reset key can be used to clear this failure condition.</p>

Reviewing Test Results For Multistep Sequences

After the test is performed, the test results will be indicated on the front panel display.

Pass: If the DUT passes the test, you will hear a short audible beep and the display will indicate the test result.

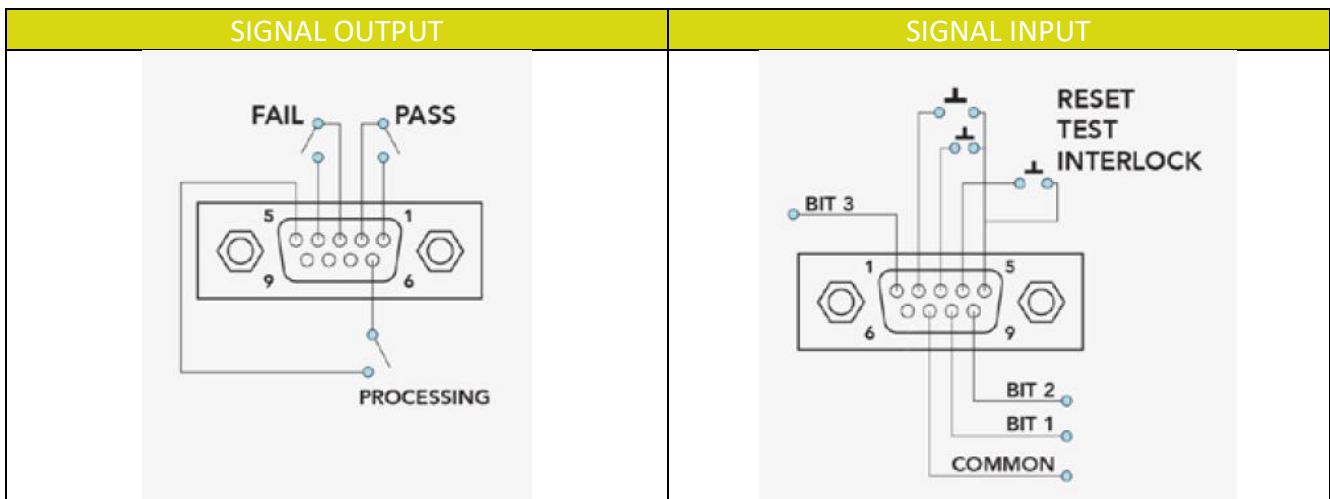
Fail: If a failure occurs, you will hear a long audible alarm and the red flashing indicator will light up. To stop the alarm, press the RESET button.

The test results from the memories that are executed can be reviewing by turning the rotary knob left or right. Successive rotation of the knob will continue advancing to the next result. The results of the last step in the process will be followed by the first step when scrolling through the results. Results can be reviewed at any time before the next test is executed. All results are cleared at the start of the next test cycle.

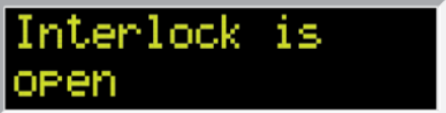
Using The Remote I/O

Two 9-pin “D” type connectors are mounted on the rear panel that provides REMOTE-INPUT-OUTPUT control and information.

- These connectors mate with standard 9 pin D-sub-miniature connector provided by the user.
- The output mates to a male (plug) connector while the input mates to a female (receptacle) connector.
- For best performance, a shielded cable should be used. To avoid ground loops, the shield should not be grounded at both ends of the cable.



Signals On Remote I/O

REMOTE INPUT/OUTPUT		
Remote Output		
Output Signal	Pins	Description
PASS	1 and 2	The relay contact closes after detecting that the device under test passed all tests. The connection is opened when the next test is initiated or the reset function is activated.
FAIL	3 and 4	The relay contact closes after detecting the device under test failed any test. The connection is opened when the next test is initiated or the reset function activated.
PROCESSING	5 and 6	The relay contact closes while the tester is performing a test. The connection is opened at the end of the test.
<p>These are normally open free contacts and will not provide any voltage or current. The ratings of the contacts are 1 AAC/250 VAC (0.5 ADC). When a terminal becomes active, the relay closes thereby allowing the external voltage to operate an external device.</p>		
Remote Input		
Input Signal	Pins	Description
TEST	3 and 5	A normally open momentary switch can be wired across pins 3 and 5 to allow remote operation of the TEST function.
RESET	2 and 5	A normally open momentary switch can be wired across pins 2 and 5 to allow remote operation of the RESET function. For safety, the front panel RESET button remains active even when a remote reset switch is connected so that high voltage can be shut down from either location.
INTERLOCK	4 and 5	<p>Remote Interlock utilizes a set of closed contacts to enable the tester's output. The output of the tester will be disabled under the following conditions:</p> <ul style="list-style-type: none"> ● If the Interlock contacts are open and the TEST button is pushed. ● If the interlock contacts are opened during a test (test will automatically abort). <p>A pop-up message will be displayed on the screen:</p>  <p>The tester can still be used without the external interlock device as long as the Interlock Connector (P/N # 38075 provided with unit) is plugged into the Remote Interface, Signal Input port. If there is nothing connected to the Remote Interface, Signal Input port to provide a connection to the interlock, the tester will not perform tests.</p>
<p>When the PLC Remote mode is ON, the tester will respond to simple switch or relay contacts closures. When the PLC Remote function is ON the TEST button on the front panel will be disabled.</p>		

Remote Memory Bit Selection

Remote Signal Inputs and Memory Access

- The Remote Memory Select function gives you the capability to quickly select and initiate a test remotely.
- You can access first six (6) pre-programmed memories by connecting pins 1, 8 and 9 to the common pin 7, in different combinations.
- The memory select bits should be set simultaneously and remain set for a minimum of 20ms to guarantee that the correct memory will be selected.
- The memory select bits may be set in sequential manner, provided that the time delay between each bit is less than 4ms.
- When the desired bit pattern has been established it should remain set for a minimum of 20ms to guarantee that the correct memory will be selected.
- It may be necessary to “OR” the momentary switches (relay contacts) to prevent incorrect program selection due to timing errors.

REMOTE FILE SELECT TRUTH TABLE			
BIT 3	BIT 2	BIT 1	MEM#
0	0	1	1
0	1	0	2
0	1	1	3

WARNING

ACTIVATING TEST PROGRAM FUNCTIONS THROUGH THE REMOTE CONNECTOR SELECTS THE MEMORY AND STARTS THE TEST THAT IS PRE-PROGRAMMED INTO THAT MEMORY.

CAUTION

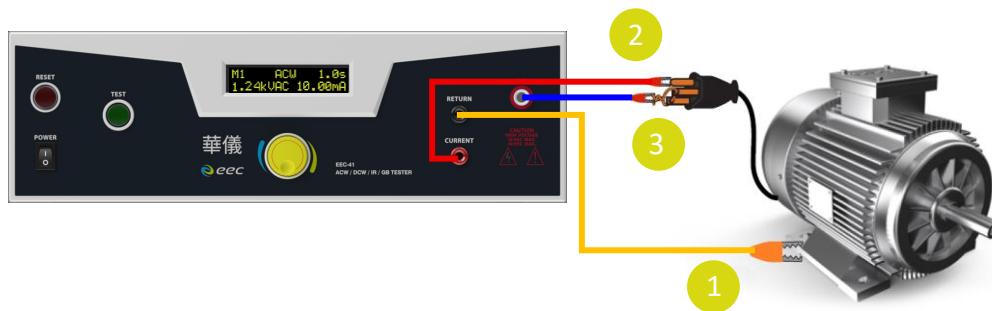
Do not connect voltage or current to the signal inputs. Applying voltage to the signal input could result in damage to the control circuitry

Using The Tester Accessories

WARNING

NEVER CONNECT THE ADAPTER BOX OR TEST LEADS TO THE TESTER WHILE THE HIGH VOLTAGE OUTPUTS ARE ENERGIZED.

Using The Test Leads



- 1 Connect the black return lead (99-10865-01) to the front panel return output terminal and connect the other end of the lead to the dead metal on the chassis of the DUT.
- 2 If you are performing a Ground Bond test, connect one end of the high current lead (99-10866-01) to the front panel current output terminal and the other end to the ground pin of the DUT line cord.
- 3 If you are using the high voltage lead (04040A-08, w/ red clip) or probe, connect it to the front panel high voltage terminal and connect the other end of the cable to both the hot and neutral pins of the line cord.

Appendix A - Installation And Test Operator Information

Installation

1. Unpacking And Inspection

If the shipping carton is damaged, inspect the contents for visible damage such as dents, scratches, or broken meters. If the tester is damaged, notify the carrier and EEC customer support department immediately. Please save the shipping carton and packing material for the carrier's inspection. Our customer support department will assist you in the repair or replacement of your tester. Please do not return your product without first notifying us and receiving an RMA (return materials authorization) number.

2. Safe Lifting And Carrying Instructions

Proper methods of lifting and carrying can help to protect against injury. Follow the Recommendations below to ensure that testers are handled in a safe manner.

- Determine if the tester can be lifted by one individual or requires additional support.
- Make sure that your balance is centered and your feet are properly spaced, shoulder width apart behind the tester.
- Bend at the knees and make sure your back is straight.
- Grip the tester with your fingers and palms, and do not lift unless your back is straight.
- Lift up with your legs, not your back.
- Keep the tester close to your body while carrying.
- Lower the tester by bending your knees. Keep your back straight.

3. Contents Of The Carton

Inside the carton will be the following:

DESCRIPTION	PART NUMBER
EEC-41 Tester	Hipot, Ground Bond, IR Tester
High Voltage Lead	04040A-08
Ground Bond Return Lead	1197
Ground Bond Test Lead	1196
Fuse	9-10168-01
Interlock Connector	38075
USB Cable*	39066
Line Cord	38071 15A

* Only included if USB option is ordered



ONLY ACCESSORIES WHICH MEET THE MANUFACTURER'S SPECIFICATION SHALL BE USED.

4. Preparation For Use

Power Requirements and Line Voltage Selection



This tester requires a power source of either 115 volts AC \pm 10%, 47-63 Hz single phase or 230 volts AC \pm 10%, 47-63 Hz single phase. In addition, please be sure the correct fuse is selected and installed while the tester is in the off position.

5. Power Cable



BEFORE CONNECTING POWER TO THIS TESTER, THE PROTECTIVE GROUND (EARTH) TERMINALS OF THIS TESTER MUST BE CONNECTED TO THE PROTECTIVE CONDUCTOR OF THE LINE (MAINS) POWER CORD. THE MAIN PLUG SHALL ONLY BE INSERTED IN A SOCKET OUTLET (RECEPTACLE) PROVIDED WITH A PROTECTIVE GROUND (EARTH) CONTACT. THIS PROTECTIVE GROUND (EARTH) MUST NOT BE DEFEATED BY THE USE OF AN EXTENSION CORD (POWER CABLE) WITHOUT A PROTECTIVE CONDUCTOR (GROUNDING).

This tester is shipped with a three-wire power cable. When this cable is connected to an appropriate AC power source, this cable connects the chassis to earth ground. The type of power cable shipped with each tester depends on the country of destination.

Operating Environment

This equipment is intended for indoor use only. The equipment has been evaluated according to Installation Category II and Pollution Degree 2 as specified in IEC 664

This tester may be operated within the following environmental conditions:

Temperature.....32° - 104° F (0° - 40° C)
Relative humidity.....20 - 80%



DO NOT BLOCK ANY VENTILATION OPENINGS TO PREVENT OVER HEATING OF THE EQUIPMENT. KEEP THE VENTILATION SLITS UNCOVERED DURING OPERATION. FAILURE TO DO SO COULD CAUSE THE TESTER TO OVERHEAT AND MAY DAMAGE INTERNAL COMPONENTS.

If the tester is used in a matter not specified by the manufacturer, the protection provided by the tester may be impaired.

Storage And Shipment

Environment

This tester may be stored or shipped in environments with the following limits:

Temperature.....-40° - 167° F (-40° - 75°C)

Altitude..... 50,000 feet (15,240 meters)

The tester should also be protected against temperature extremes which may cause condensation within the tester.

Packaging

Please enclose the tester with all options, accessories, and test leads. Indicate the nature of the problem or type of service needed. Also, please mark the container “FRAGILE” to insure proper handling.

Packaging Instructions:

1. Be sure to REMOVE ALL ACCESSORIES and the INTERLOCK DISABLE from the tester.
2. Wrap the tester in a bubble pack or similar foam. Enclose the same information as above.
3. Use a strong double-wall container that is made for shipping instrumentation. 350 lb. test material is adequate.
4. Use a layer of shock-absorbing material 70 to 100 mm (3 to 4 inch) thick around all sides of the tester. Protect the control panel with cardboard.
5. Seal the container securely.
6. Mark the container “FRAGILE” to insure proper handling.
7. Please ship models via Federal Express or UPS air.

Test Operator And Safety Considerations

1. Qualifications

This tester generates voltages and currents which can cause harmful or fatal electric shock and must only be operated by a skilled worker trained in its use.

The operator should understand the electrical fundamentals of voltage, current, and resistance.

2. Safety Procedures

Operators should be thoroughly trained to follow these and all other applicable safety rules and procedures before they begin a test. Defeating any safety system should be treated as a serious offense and should result in severe penalties, such as removal from the Hipot testing job. Allowing unauthorized personnel in the area during a test should also be dealt with as a serious offense.

3. Dress

Operators should not wear jewelry that could accidentally complete a circuit.

4. Medical Restrictions

This tester should not be operated by personnel with heart ailments or devices such as pacemakers.

5. Test Procedures

WARNING

NEVER PERFORM A HIPOT TEST ON ENERGIZED CIRCUITRY OR EQUIPMENT!

If the tester has an external safety-ground connection, be sure that this is connected. Then connect the return lead first for any test regardless of whether the device under test is a sample of insulating material tested with electrodes, a component tested with the high voltage test lead, or a cord-connected device with a two or three-prong plug.

Plug in the high voltage test lead only when it is being used. Handle its clip only by the insulator-never touch the clip directly. Be certain that the operator has control over any remote test switches connected to the Hipot. Double-check the return and high voltage connections to be certain that they are proper and secure.

WARNING

NEVER TOUCH THE ITEM UNDER TEST OR ANYTHING CONNECTED TO IT WHILE HIGH VOLTAGE IS PRESENT DURING THE HIPOT TEST.

When testing with DC, always discharge the capacitance of the item under test and anything the high voltage may have contacted-such as test fixtures-before handling it or disconnecting the test leads.

Hot stick probes can be used to discharge any capacitance in the item under test as a further safety precaution. A hot stick is a non-conducting rod about two feet long with a metal probe at the end which is connected to a wire. To discharge the device under test, two hot sticks are required. First connect both probe wires to a good earth ground. Then touch one probe tip to the same place the return lead was connected. While holding the first probe in place, touch the second probe tip to the same place where the high voltage lead was connected.

6. Test Station

Location

Select an area away from the main stream of activity which employees do not walk through in performing their normal duties. If this is not practical because of production line flow, then the area should be roped off and marked for **HIGH VOLTAGE TESTING**. No employees other than the test operators should be allowed inside. If benches are placed back-to-back, be especially careful about the use of the bench opposite the test station. Signs should be posted: “**DANGER - HIGH VOLTAGE TEST IN PROGRESS - UNAUTHORIZED PERSONNEL KEEP AWAY**”.

Power

Voltage-Hipot Test Equipment must be connected to a good ground. Be certain that the power wiring to the test bench is properly polarized and that the proper low resistance bonding to ground is in place.

Power to the test station should be arranged so that it can be shut off by one prominently marked switch located at the entrance to the test area. In the event of an emergency, anyone can cut off the power before entering the test area to offer assistance.

WARNING

THE MAINS PLUG IS USED AS THE DISCONNECTING DEVICE AND SHALL REMAIN READILY OPERABLE. THE SOCKET-OUTLET SHALL BE INSTALLED NEAR THE EQUIPMENT AND SHALL BE EASILY ACCESSIBLE.

CAUTION

Do not replace the power supply cord with an improperly rated cord. For North American: A UL listed and CSA labeled power cord must be used with the tester in the United States and Canada. The power cord must include a NEMA5-15 style male plug, SVT or SJT cord sets, and be rated for at least 125VAC, 10A, number 16 gauge (or 125VAC, 15A, number 14 gauge) wire or larger, and the length of the cord does not exceed 2 m must be used. For European: A certified power supply cord not lighter than light PVC sheathed flexible cord according to IEC 60227, designation H03 VV-F or H03 VVH2-F (for equipment mass not

exceeding 3 kg), or H05 VV-F or H05 VVH2-F2 (for equipment mass exceeding 3 kg), and be rated for at least 3G 0.75 mm² (for rated current up to 10A) or 3G 1.0mm² (for rated current over 10A up to 16A) wire or larger, and the length of the cord does not exceed 2 m must be used.

Work Area

Perform the tests on a non-conducting table or workbench, if possible. There should not be any metal in the work area between the operator and the location where products being tested will be positioned

Position the tester so the operator does not have to reach over the product under test to activate or adjust the tester. If the product or component being tested is small, it may be possible to construct guards or an enclosure, made of a non-conducting material such as clear acrylic, such that the item being tested is within the guards or enclosure during the test, and fit them with switches so that the tester will not operate unless the guards are in place or the enclosure closed. The outlet which is used to provide power to the tester should be easily accessible.

Keep the area clean and uncluttered. All test equipment and test leads not absolutely necessary for the test should be removed from the test bench and put away. It should be clear to both the operator and to any observers which product is being tested, and which ones are waiting to be tested or have already been tested. If the tester is used in a matter not specified by EEC the protection provided by the tester may be impaired.

Do not perform Hipot tests in a combustible atmosphere or in any area where combustible materials are present.

KEY SAFETY POINTS TO REMEMBER

- Keep unqualified and unauthorized personnel away from the test area.
- Arrange the test station in a safe and orderly manner.
- Never touch the product or connections during a test.
- In case of any problem, turn off the high voltage first.
- Properly discharge any item tested with DC before touching connections.

Appendix B – EEC-41 Tester Specifications

Unless otherwise stated, accuracies are relative to a laboratory standard measurement.

Why use the term “Counts”?

EEC-41 publishes some specifications using COUNTS which allows us to provide a better indication of the tester’s capabilities across measurement ranges. A COUNT refers to the lowest resolution of the display for a given measurement range. For example, if the resolution for voltage is 1V then 2 counts = 2V.

Model	EEC-41	
INPUT		
Voltage	100 - 120Vac / 200 - 240Vac±10% Auto Range	
Frequency	50/60Hz ± 5%	
Fuse	15A / 250Vac Fast-Blow	
DIELECTRIC WITHSTAND TEST MODE		
Output Rating	3KV @ 100.0mA AC 4KV @ 5mA DC	
Voltage Setting	Range:	0.00 – 3.00kV AC 0.00 – 4.00kV DC
	Resolution:	0.01kV
	Accuracy:	±(1.5% of setting + 5V)
Voltage Display	Range:	0.00 – 4.00kV
	Resolution:	0.01kV
	Accuracy:	±(1.5% of reading) ≥ 500V ±(1.5% of reading +1 count) < 500V
Current Display	Range:	0.10 – 99.99mA AC 0.02 – 5.00mA DC
	Resolution:	0.01mA
	Accuracy:	±(2% of reading + 2 counts)
	Range:	100.0mA AC
	Resolution:	0.1mA
	Accuracy:	±(2% of reading + 2 counts)
HI-Limit	Range:	0.10 – 99.99mA AC
	Resolution:	0.01mA
	Accuracy:	±(2% of setting + 6 counts)
	Range:	100.0mA AC
	Resolution:	0.1mA
	Accuracy:	±(2% of setting + 2 counts)
	Range:	0.02 – 5.00mA DC
	Resolution:	0.01mA
	Accuracy:	±(2% of setting + 2 counts)
LO-Limit	Range:	0.00 – 99.99mA AC
	Resolution:	0.01mA

	Accuracy:	±(2% of setting + 6 counts)
	Range:	100.0mA AC
	Resolution:	0.1mA
	Accuracy:	±(2% of setting + 2 counts)
	Range:	0.00 – 5.00mA DC
	Resolution:	0.01mA
	Accuracy:	±(2% of setting + 2 counts)
DC Output Ripple	<5 % (6KV / 5mA at Resistive Load)	
Maximum Capacitive Load in DC Mode	0.17µF	< 1KV
	0.09µF	< 2KV
	0.07µF	< 3KV
	0.05µF	< 4KV
AC Output Waveform	Sine Wave, Crest Factor = 1.3 – 1.5	
AC Output Frequency	Range:	50Hz/60Hz, User Selection
	Accuracy:	±0.1%
Output Regulation	±(1% of output + 5V)	
Ramp Timer	Range:	0.2 – 60.0sec
	Resolution:	0.1sec
	Accuracy:	±(0.1% of setting + 0.05 sec)
Dwell Timer	Range:	0, 0.2 – 60.0sec (0 = Continuous)
	Resolution:	0.1sec
	Accuracy:	±(0.1% of setting + 0.05 sec)
INSULATION RESISTANCE TEST MODE		
Output Voltage	Range:	100 – 1000V DC
	Resolution:	1V
	Accuracy:	±(1.5% of setting + 5V)
Voltage Display	Range:	100 – 1000V DC
	Resolution:	1V
	Accuracy:	±(1.5% of reading + 5V)
Resistance Display	Range:	1.000–1.999MΩ for 0.10–0.49kV 1.000–9.999 MΩ for ≥ 0.50kV
	Resolution:	0.001MΩ
	Accuracy:	±(7% of reading + 2 counts) for 0.10–0.49kV ±(3% of reading + 2 counts) for ≥ 0.50kV
	Range:	2.00–19.99MΩ for 0.10–0.49kV 10.00–99.99 MΩ for ≥ 0.50kV
	Resolution:	0.01MΩ
	Accuracy:	±(7% of reading + 2 counts) for 0.10–0.49kV ±(3% of reading + 2 counts) for ≥ 0.50kV
	Range:	20.0–999.9MΩ for 0.10–0.49kV 100.0–999.9 MΩ for ≥ 0.50kV
	Resolution:	0.1MΩ
	Accuracy:	±(7% of reading + 2 counts) for 0.10–0.49kV

		$\pm(3\% \text{ of reading} + 2 \text{ counts})$ for $\geq 0.50\text{kV}$
HI and LO-Limit	Range: Resolution: Accuracy:	0, 1–1000M Ω , 0 = OFF 1 M Ω Same as Resistance Display Accuracy
Ramp Timer	Range: Resolution: Accuracy:	0.1sec or 2.0sec 0.1sec $\pm(0.1\% \text{ of setting} + 0.05 \text{ sec})$
Delay Timer	Range: Resolution: Accuracy:	0, 0.5–999.9sec 0.1sec $\pm(0.1\% \text{ of setting} + 0.05 \text{ sec})$
GROUND BOND MODE		
Output AC Current, A	Range: Resolution: Accuracy:	1.0-32.0A 0.1A $\pm(2\% \text{ of setting} + 2 \text{ counts})$
Current Display	Range: Resolution: Accuracy:	0.0–32.0A 0.1A $\pm(3\% \text{ of reading} + 1 \text{ counts})$
Resistance Display	Range: Resolution: Accuracy:	0–600m Ω 1m Ω $\pm(3\% \text{ of reading} + 3 \text{ counts})$ for 1 - 5.9A, $\pm(2\% \text{ of reading} + 2 \text{ counts})$ for 6 - 32A
Output AC Voltage	8V (Fixed)	
Output Frequency	50Hz/60Hz $\pm 0.1\%$, User Selectable	
Maximum Loading	1.0–10.0A/0–600m Ω , 10.1–30.0A/0–200m Ω , 30.1–32.0A/0–150m Ω	
Offset	Range: Resolution: Accuracy:	0–100m Ω 1m Ω $\pm(2\% \text{ of setting} + 2 \text{ counts})$
HI and LO-Limit Resistance	Range: Resolution: Accuracy:	0–150m Ω (30.1-32.0A) 0–200m Ω (10.1-30.0A) 0–600m Ω (1.0-10.0A) 1m Ω $\pm(2\% \text{ of setting} + 2 \text{ counts})$
Fix Ramp Timer	Range: Resolution: Accuracy:	0.4sec 0.1sec $\pm 0.05 \text{ sec}$ 0– 250m Ω \rightarrow 0.1sec ramp up 251– 300m Ω \rightarrow 0.2sec ramp up 301– 450m Ω \rightarrow 0.3sec ramp up >450m Ω \rightarrow 0.4sec
Dwell Time	Range: Resolution: Accuracy:	0, 0.1–120.0sec 0.1sec $\pm 0.05 \text{ sec}$
GENERAL SPECIFICATIONS		
Safety Agency Listing	CE	
PLC Remote Contro	Input: Output:	Test, Reset, Interlock, Recall Memory 1–3 Pass, Fail, Test-in-Proces
Memory	3 memories	

	All memories are linkable
Security	Run Only Mode (RUN)–To avoid unauthorized access to test parameters and memory locations. Memory Mode (MEM)–Allows access to memory locations but restricts any changes in test parameters. Off–Full function
Meter Max	When a fault condition occurs during the test, the voltage meter will be shown the values of a 0.1 seconds before.
Line Cord	Detachable 6 ft (1.8 m) power cable terminated in a three-prong grounding plug.
Terminations	6 ft (1.8 m) high voltage and return leads (2) with clips. An optional remote receptacle box may be purchased for testing items terminated with a line cord. International receptacles are also available.
Mechanical	Dimensions (WxHxD): 430 x 132 x 400 Weight: 24kg
Environmental	Operating Temperature: 32° - 104°F (0° - 40°C) Relative Humidity: 20 to 80%

Appendix C - EEC-41 Options

Introduction

This section contains a list and descriptions of available factory installed options at the time of this printing. The list of options contains an option code number which can be referenced on the model option label on the rear panel of the unit when options are present.

Model Option Label

On the rear panel of the tester, you will find a label that contains the option code.

For example, your options code will appear as follows:

fitted with option 01...OPT: 01

fitted with option 01 and 02...OPT: 0102

Option List

Code	Description
OPT001	5 Memories
OPT002	USB Port
OPT003	Rear Output Kit
OPT004	5KVac/6KVdc Output
OPT006	40A Ground Bond Output

OPT001– 5 Memories

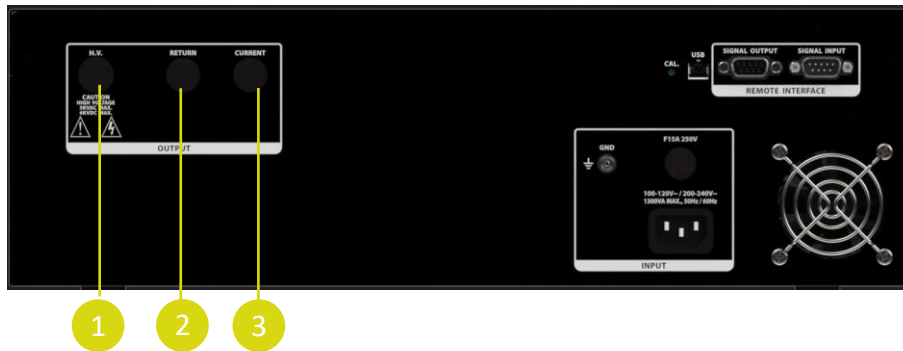
This option expands the tester's memory groups to 5.

OPT002 – USB interface

This option may be added as a serial type communication protocol. This option provides all of the function control of the USB interface. The Type B USB connector labeled “USB” is for connection of the EEC-41 Testers to any compatible PC. When selecting USB Interface, the protocol for interfacing and communicating with a PC can be found in Appendix D: Remote Bus Interface: USB of this manual.

OPT003 – Rear Output Kit

This option provides three output connections on the rear panel of the tester. These are the same as the front panel HV, RETURN and Ground Bond connections.



- 1 **High Voltage Jack** For the connection of the red high voltage test lead or three-prong receptacle adapter box. This jack is always active when performing a Hipot Test.
- 2 **Return Jack** For the connection of the black return test lead or three-prong receptacle adapter box. This jack is always active when performing a test.
- 3 **Current Jack** Connector used to attach the high current output lead, adapter box high current lead, or test fixture high current lead to the instrument. This connection provides the output current for the ground bond.

OPT004– 5KVac/6KVdc Output

This option the maximum voltage of the tester to 5KV AC and 6KV DC. The following specifications table is applicable when this option is installed in the tester:

DIELECTRIC WITHSTAND TEST MODE		
Output Rating	5KV @ 100.0mA AC 6KV @ 5mA DC	
Voltage Setting	Range:	0.00 – 5.00kV AC 0.00 – 6.00kV DC
	Resolution:	0.01kV
	Accuracy:	±(1.5% of setting + 5V)
Voltage Display	Range:	0.00 – 5.00kV AC 0.00 – 6.00kV DC
	Resolution:	0.01kV
	Accuracy:	±(1.5% of reading) ≥ 500V ±(1.5% of reading +1 count) < 500V
Current Display	Range:	0.10 – 99.99mA AC 0.02 – 5.00mA DC
	Resolution:	0.01mA
	Accuracy:	±(2% of reading + 2 counts)
	Range:	100.0mA AC
	Resolution:	0.1mA
	Accuracy:	±(2% of reading + 2 counts)

HI-Limit	Range:	0.10 – 99.99mA AC
	Resolution:	0.01mA
	Accuracy:	±(2% of setting + 6 counts)
	Range:	100.0mA AC
	Resolution:	0.1mA
	Accuracy:	±(2% of setting + 2 counts)
	Range:	0.02 – 5.00mA DC
	Resolution:	0.01mA
	Accuracy:	±(2% of setting + 2 counts)
LO-Limit	Range:	0.00 – 99.99mA AC
	Resolution:	0.01mA
	Accuracy:	±(2% of setting + 6 counts)
	Range:	100.0mA AC
	Resolution:	0.1mA
	Accuracy:	±(2% of setting + 2 counts)
	Range:	0.00 – 5.00mA DC
	Resolution:	0.01mA
	Accuracy:	±(2% of setting + 2 counts)
DC Output Ripple	<5 % (6KV / 5mA at Resistive Load)	
Maximum Capacitive Load in DC Mode	0.17µF	< 1KV
	0.09µF	< 2KV
	0.07µF	< 3KV
	0.05µF	< 4KV
	0.04uF	< 5KV
	0.03uF	< 6KV
AC Output Waveform	Sine Wave, Crest Factor = 1.3 – 1.5	
AC Output Frequency	Range:	50Hz/60Hz, User Selection
	Accuracy:	±0.1%
Output Regulation	±(1% of output + 5V)	
Ramp Timer	Range:	0.2 – 60.0sec
	Resolution:	0.1sec
	Accuracy:	±(0.1% of setting + 0.05 sec)
Dwell Timer	Range:	0, 0.2 – 60.0sec (0 = Continuous)
	Resolution:	0.1sec
	Accuracy:	±(0.1% of setting + 0.05 sec)

OPT006 – 40A Ground Bond Output

This option the maximum current of the tester to 40A AC. The following specifications table is applicable when this option is installed in the tester:

GROUND BOND MODE		
Output AC Current, A	Range: Resolution: Accuracy:	1.0-40.0A 0.1A $\pm(2\% \text{ of setting} + 2 \text{ counts})$
Current Display	Range: Resolution: Accuracy:	0.0-40.0A 0.1A $\pm(3\% \text{ of reading} + 1 \text{ counts})$
Resistance Display	Range: Resolution: Accuracy:	0-600m Ω 1m Ω $\pm(3\% \text{ of reading} + 3 \text{ counts})$ for 1 - 5.9A, $\pm(2\% \text{ of reading} + 2 \text{ counts})$ for 6 - 40A
Output AC Voltage	8V (Fixed)	
Output Frequency	50Hz/60Hz $\pm 0.1\%$, User Selectable	
Maximum Loading	1.0-10.0A/0-600m Ω , 10.1-30.0A/0-200m Ω , 30.1-40.0A/0-150m Ω	
Offset	Range: Resolution: Accuracy:	0-100m Ω 1m Ω $\pm(2\% \text{ of setting} + 2 \text{ counts})$
HI and LO-Limit Resistance	Range: Resolution: Accuracy:	0-150m Ω (30.1-40.0A) 0-200m Ω (10.1-30.0A) 0-600m Ω (1.0-10.0A) 1m Ω $\pm(2\% \text{ of setting} + 2 \text{ counts})$
Fix Ramp Timer	Range: Resolution: Accuracy:	0.4sec 0.1sec $\pm 0.05 \text{ sec}$ 0- 250m Ω \rightarrow 0.1sec ramp up 251- 300m Ω \rightarrow 0.2sec ramp up 301- 450m Ω \rightarrow 0.3sec ramp up >450m Ω \rightarrow 0.4sec
Dwell Time	Range: Resolution: Accuracy:	0, 0.1-120.0sec 0.1sec $\pm 0.05 \text{ sec}$

Appendix D - Remote Bus Interface: USB

This section provides information on the proper use and configuration of bus remote interface.

USB Interface

This interface provides all of the control commands and parameter setting commands. All commands can be found in the command list of this manual. The USB interface card requires you to download a driver in order for the instrument to recognize the USB interface. The driver can be found on the EEC website:

<https://www.ikonixasia.com/drivers-software-downloads/>

Click on “USB Driver” to download the driver. This link contains an automatic extract and install program. Follow the instructions of the installation program to initialize the driver install. NOTE: The USB port acts as a USB to RS-232 converter. As a result, the PC will recognize the USB port as a virtual COM port.

The COM port should have the following configuration: 9600 baud, 8 data bits, 1 stop bit, no parity. This interface does not support XON/XOFF protocol or any hardware handshaking.

When sending command over the USB bus, the tester will send a response string of 06 hex or 6 decimal, the Acknowledge (ACK) ASCII control code if the transfer was recognized and completed by the tester. If there is an error with the command string that is sent, the tester will respond with 15 hex or 21 decimal, the Not Acknowledge (NAK) ASCII control code. The ACK or NAK response allows for software handshaking, to monitor and control data flow. When requesting data from the tester, it will automatically send the data back to the controller input buffer. The controller input buffer will accumulate data being sent from the tester including the ACK and NAK response strings, until it has been read by the controller.

USB Interface Command List

The USB bus will automatically send any response back to the controller’s input buffer. Note that the commands are case sensitive and must be typed in capital letters. Each command string should be terminated by the ASCII control code, New Line , or OAh.

The following conventions are used to describe the commands syntax for the EEC-41 testers. Braces ({ }) enclose each parameter for a command string. Triangle brackets (< >) indicate that you must substitute a value for the enclosed parameter. The Pipe (|) is used to separate different parameter options for a command. The command and the parameter data must be separated with a space. All commands that end with a question mark (?) are query commands and require an IEEE-488 read command to retrieve the data from the device’s output buffer.

Test Execution Commands

The following commands are used to control actual output voltage and current from the tester. Please observe all safety precautions.

Command	Description
TEST	Execute a Test
RESET	Abort a Test in Process or Reset Failures
SAO	Set Continuity Auto Offset

TEST - Starts the test sequence at the selected step loaded into memory (RAM).

RESET - Stop or abort a test. Also used to reset a latched failure condition.

SAO - Set the offset for the Continuity test. The cables and any test fixture should be connected before executing the command. This command will perform an actual test and all safety precautions should be observed when using this command.

Memory Location Edits and Companion Queries

The following commands are used to create or modify Test Setup at each Memory Locations.

Command	Description	Value
FL <memory location number>	Load Test Located at Memory Location	Memory location number = 1-3
FL?	Query Memory Location	1-3
SAA	Add ACW Test	
SAD	Add DCW Test	
SAI	Add IR Test	
SAG	Add GND Test	
ADD <ACW,p,p,p,p,p,p>	Add all parameters for ACW Test	ACW, Voltage(kV), HI-Limit(mA), LO-Limit(mA), Ramp(s), Dwell(s), Frequency, Connect(ON/OFF)
ADD <DCW,p,p,p,p,p,p >	Add all parameters for DCW Test	DCW, Voltage(kV), HI-Limit(mA), LO-Limit(mA), Ramp(s), Dwell(s), Connect(ON/OFF)
ADD <IR,p,p,p,p,p,p>	Add all parameters for IR Test	IR, Voltage(V), HI-Limit(Ω), LO-Limit(Ω), Ramp(s), Delay(s), Connect (ON/OFF)
ADD <GND,p,p,p,p,p,p>	Add all parameters for GND Test	GND, Currnet, HI-Limit(m Ω), LO-Limit(m Ω), Dwell(s), Frequency, Offset(m Ω), Connect (ON/OFF)

FL <memory location number> - Load a memory location from non-volatile memory into random access memory RAM.

The parameter values should use complete text and not use the coded values that are associated with the individual parameter setting commands. Such as "ON" and "OFF" and any toggle field that

use words or phrases like “OPEN”, “CLOSE”. The LS? companion command will also list all parameters in complete text as they appear on the setting screen.

FL? - Query the memory location of the current selection.

ADD command needs test type and parameters listed below:

	ACW	DCW	IR	GND
1	Voltage	Voltage	Voltage	Current
2	HI-Limit	HI-Limit	HI-Limit	HI-Limit
3	LO-Limit	LO-Limit	LO-Limit	LO-Limit
4	Ramp Up	Ramp Up	Ramp Up	Dwell
5	Dwell	Dwell	Delay	Offset
6	Frequency	Connect (ON/OFF)	Connect (ON/OFF)	Frequency
7	Connect (ON/OFF)			Connect (ON/OFF)

Test Parameter Editing Commands

These commands are used to modify the test parameter within each memory. These commands require a parameter value to be included with the command. The companion query command will read the parameter. The writing of the parameter requires that the unit not be included with the value, only the numeric value should be included with the command. Also when the query commands are used the response will not include the units characters. Many of the commands will function the same way for multiple test types, however the input range may be different and therefore used a different possible set of values.

Command	Name	Test Types	Values
ECC {1 0} ECC?	Edit Memory Connect	ALL	1=On, 0=Off
EC <value> EC?	Edit Current	GND	1.00 – 40.00A
EDE <value> EDE?	Edit Delay	IR	0.0, 0.5 - 999.9s 0.0 = Continuous
EDW <value> EDW?	Edit Dwell	ACW DCW GND	0.0, 0.2 – 60.0s 0.0, 0.2 – 60.0s 0.0, 0.1 – 120.0s 0.0 = Continuous
EF {1 0} EF?	Edit Frequency	ACW GND	1=60 Hz, 0=50 Hz
EH <value> EH?	Edit HI-Limit	ACW DCW IR GND	0.10 – 99.99 (mA) 0.02 – 5.00 (mA) 0, 1– 1000 (MΩ) 0 – 600 (mΩ)

Command	Name	Test Types	Values
EL <value> EL?	Edit Lo-Limit	ACW DCW IR GND	0.0 – 99.99 (mA) 0.0 – 5.00 (mA) 0 – 1000 (MΩ) 0 – 600 (mΩ)
EO <value> EO?	Edit Offset	GND	0 – 100 (mΩ)
ERU <value> ERU ?	Edit Ramp	ACW DCW IR	0.2 – 60.0 (sec) 0.2 – 60.0 (sec) 0.1, 2.0 (sec)
EV <value> EV?	Edit Voltage	ACW DCW IR	0.00 – 3.00 (kV) 0.00 – 4.00 (kV) 100 – 1000 (V)

System Parameter Editing Commands and Companion Queries

These commands are used to modify the system parameters for the tester. These commands require a parameter value to be included with the command.

Command	Name	Value
SPR {1 0} SPR?	PLC Remote ON/OFF	1=On, 0=Off
SSI {1 0} SSI?	Single Step ON/OFF	1=On, 0=Off
SF {1 0} SF?	Fail Stop ON/OFF	1=On, 0=Off
SEC 0 SEC n,mmm	Edit Security	n: 0=off, 1=run, 2=mem, mmm=password
SEC?	Query security	0=OFF, 1=run, 2=mem
SDUT SDUT?	Edit Dual Test	1=On, 0=Off
SFW	Query Firmware version	Version

Query Commands

These query commands will retrieve data from the tester. These commands include functions for retrieving test data, test results and remote hardware.

Command	Name	Value
TD?	List Testing Data	Data from test in Process
RD <memory location>?	Result Data Query by memory locaiton	1-3
RR?	Read Reset Query	1=Open, 0=Closed
RI?	Read Interlock Query	1=Open, 0=Closed
LS?	List Step Parameters	
LS <memory location>?	List Step Parameters by memory location	Memory Location = 1-3
RDM?	Read Current Max	Returns max leakage recorded during Hipot test

TD? - Read the active data being displayed on the LCD display while the test is in process. It will also read the last data taken when the test sequence has completed. Each parameter is separated by commas and includes memory location, test type, test status, and metering. The syntax for this command response is {memory, test type, status, meter 1, meter 2, meter 3}. **{Memory, GND, Status, Current(A), Resistance(mΩ), Time(s)}**

RD <memory location>? - Read the results for an individual memory location. Each parameter is separated by commas and includes memory location, test type, test status, and metering. The syntax for this command response is {memory, test type, status, meter 1, meter 2, meter 3}. **{Memory, GND, Status, Current(A), Resistance(mΩ), Time(s)}**

RR? - Read the remote Reset input signal. When the remote reset has to be activated by closing the contacts the query will return a value of 0 to indicate the tester is being Reset.

RI? - Read the remote Interlock input signal. When the remote Interlock has to be activated by opening the contacts the query will return a value of 1 to indicate the tester is in the Interlock state and will not be able to generate output voltage or current.

LS? - Lists all the Parameters for the individual step that is currently selected.

The response will be formatted as follows;

{Memory, ACW, Status, Voltage(kV), Current(mA), Time(s)}

{Memory, DCW, Status, Voltage(kV), Current(mA), Time(s)}

{Memory, IR, Status, Voltage(V), Resistance(MΩ), Time(s)}

{Memory,GND, Status, Current(A), Resistance(mΩ), Time(s)}

LS <memory location>? - Lists all the Parameters for the individual step indicated by step number = 1-3.

{Memory, ACW, Status, Voltage(kV), Current(mA), Time(s)}
 {Memory, DCW, Status, Voltage(kV), Current(mA), Time(s)}
 {Memory, IR, Status, Voltage(V), Resistance(MΩ), Time(s)}
 {Memory,GND, Status, Current(A), Resistance(mΩ), Time(s)}

RDM? - Returns max leakage recorded during hipot test.

SFW? - Return the current firmware version of the tester.

IEEE 488.2 Common Commands

These commands are required by the IEEE-488.2 standard with the exception of *PSC, *PSC?. Most of these commands are not available over the RS-232 bus except for the *IDN? command which can be used to retrieve the tester identification information, and the four status reporting commands *ESR?, *ESE, *ESE? and *STB?.

Command	Name	Value
*IDN?	Identification Query	EXTECH, Model Number, Serial Number, Firmware Revision
*RST	Reset Command	Reset Tester
*TST?	Self-Test Query	00H=OK 01H=TEST EEPROM ERROR
*CLS	Clear Status Command	Clear Standard Event Status Register Clear Service Request Register
*OPC	Operation Complete Command	When TEST command ok setting ESR BIT0 =1
*OPC?	Operation Complete Query	1 = TEST completed ok 0 = TEST in process
*WAI	Wait-to-Continue Command	
*PSC {1 0}	Power-on Status Clear Command	1 = Power-on clear enable registers 0 = Power-on load previous enable registers
*PSC?	Power-on Status Clear Query	
*ESR?	Standard Event Status Register Query	BIT 0, 01H,(1) Operation Complete BIT 1,02H,(2) Not Used BIT 2,04H,(4) Query Error BIT 3,08H,(8) Device Error BIT 4,10H,(16) Execution Error BIT 5,20H,(32) Command Error BIT 6,40H,(64) Not Used BIT 7,80H,(128) Power On

Command	Name	Value
*ESE <value>	Standard Event Status Enable Command	0 - 255
*ESE?	Standard Event Status Enable Query	0 - 255
*STB?	Read Status Byte Query	BIT 0, 01H, (1) ALL PASS BIT 1, 02H, (2) FAIL BIT 2, 04H, (4) ABORT BIT 3, 08H, (8) PROCESS BIT 4, 10H, (16) Message Available BIT 5, 20H, (32) Standard Event (ESB) BIT 6, 40H, (64) Request Service (MSS) BIT 7, 80H, (128) PROMPT
*SRE	Service Request Enable Command	0 - 255
*SRE?	Service Request Enable Query	0 - 255

***IDN?** - Read the tester identification string. Company =EXTECH.

***RST** - Reset the tester to original power on configuration. Does not clear Enable register for Standard Summary Status or Standard Event Registers. Does not clear the output queue. Does not clear the power-on-status-clear flag.

***TST?** - Performs a self test of the tester data memory. Returns 0 if it is successful or 1 if the test fails.

***CLS** - Clears the Status Byte summary register and event registers. Does not clear the Enable registers.

***OPC** - Sets the operation complete bit (bit 0) in the Standard Event register after a command is completed.

***OPC?** - Returns an ASCII "1" after the command is executed.

***WAI** - After the command is executed, it prevents the tester from executing any further query or commands until the nooperation-pending flag is TRUE.

***PSC {1|0}** - Sets the power-on status clear bit. When set to 1 the Standard Event Enable register and Status Byte Enable registers will be cleared when power is turned ON. 0 setting indicates the Enable registers will be loaded with Enable register masks from non-volatile memory at power ON.

***PSC?** - Queries the power-on status clear setting. Returns 0 or 1.

***ESR?** - Queries the Standard Event register. Returns the decimal value of the binary-weighted sum

of bits.

***ESE** - Standard Event enable register controls which bits will be logically ordered together to generate the Event Summary bit 5 (ESB) within the Status Byte.

***ESE?** - Queries the Standard Event enable register. Returns the decimal value of the binary-weighted sum of bits.

***STB?** - Read the Status Byte. Returns the decimal value of the binary-weighted sum of bits.

***SRE** - Service Request enable register controls which bits from the Status Byte should be use to generate a service request when the bit value = 1.

***SRE?** - Queries the Service Request enable register. Returns the decimal value of binary-weighted sum of bits.

Appendix E - Service And Maintenance

User Service

To prevent electric shock do not remove the tester cover. There are no user serviceable parts inside. Routine maintenance or cleaning of internal parts is not necessary. Any external cleaning should be done with a clean dry or slightly damp cloth. Avoid the use of cleaning agents, or chemicals to prevent any foreign liquid from entering the cabinet through ventilation holes or damaging controls and switches. Also some chemicals may damage plastic parts or lettering. Schematics, when provided, are for reference only. Any replacement cables and high voltage components should be acquired directly from EEC Refer servicing to an EEC. authorized service center.

Service Interval

The tester and its power cord, test leads, and accessories must be returned at least once a year to an EEC authorized service center for calibration and inspection of safety related components. EEC will not be held liable for injuries suffered if the tester is not returned for its annual safety check and maintained properly.

User Modifications

Unauthorized user modifications will void your warranty. EEC will not be responsible for any injuries sustained due to unauthorized equipment modifications or use of parts not specified by EEC. Testers returned to EEC with unsafe modifications will be returned to their original operating condition at your expense.